# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3521299

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date	
YA-LIN HSIAO	09/03/2015	

#### **RECEIVING PARTY DATA**

Name:	HTC CORPORATION
Street Address:	NO. 23, XINGHUA ROAD, TAOYUAN DISTRICT,
City:	TAOYUAN CITY
State/Country:	TAIWAN
Postal Code:	330

### **PROPERTY NUMBERS Total: 1**

Property Type	Number				
Application Number:	14850964				

#### **CORRESPONDENCE DATA**

**Fax Number:** (510)580-7280

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE

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ATTORNEY DOCKET NUMBER:	54144-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	09/11/2015

# **Total Attachments: 2**

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PATENT 503474673 REEL: 036537 FRAME: 0647

# ASSIGNMENT

# WHEREAS,

#### 1. Ya-Lin Hsiao

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: ELECTRONIC DEVICE AND HEAT DISSIPATION PLATE

[ ] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS 1. HTC Corporation

of No. 23, Xinghua Road, Taoyuan District, Taoyuan City 330, Taiwan (R.O.C.)

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

PATENT REEL: 036537 FRAME: 0648 HTC103237-1-US 54144-US-PA

# **ASSIGNMENT CONTINUED**

IN TESTIMONY WHEREOF,	Assignor h	as/have	signed	his/her/their	name(s)	on the	date(s)
ndicated.							

Signature: Ya-LTn HSTAD Date: >015,0903

Sole or First Joint Inventor: Ya-Lin Hsiao

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PATENT REEL: 036537 FRAME: 0649